IEEE P802.11  
Wireless LANs

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| REVme January-March teleconference agenda | | | | |
| Date: 2023-02-21 | | | | |
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Abstract

This document contains the draft agenda for the TGme Task Group for January-March 2023 teleconference meetings.

R0: Initial draft, posted prior to the 2023-01-27 teleconference

R1: Agenda changes based on offline feedback

R2: Agenda updates based on 2023-01-27 teleconference

R3: Agenda updates prior to the 2023-02-03 teleconference

R4: Agenda updates after the 2023-02-03 teleconference

R5: Agenda updates after the 2023-02-06 teleconference

R6: Agenda updates prior to the 2023-02-10 teleconference

R7: Agenda updates prior to the 2023-02-13 teleconference

R8: Agenda updates after the 2023-02-13 teleconference

R9: Further agenda updates

# 2023 January-March Teleconference Agendas

TGme will hold teleconferences for the purpose of moving to initial LB.

See the TGme calendar entries at: <http://grouper.ieee.org/groups/802/11/>

**The draft agenda for the teleconferences is below:**

1.       Call to order, attendance (<https://imat.ieee.org/attendance> ), and patent and copyright policy

a.       **Patent Policy: Ways to inform IEEE:**

1. Cause an LOA to be submitted to the IEEE-SA ([patcom@ieee.org](mailto:patcom@ieee.org)); or
2. Provide the chair of this group with the identity of the holder(s) of any and all such claims as soon as possible; or
3. Speak up now and respond to this Call for Potentially Essential Patents

If anyone in this meeting is personally aware of the holder of any patent claims that are potentially essential to implementation of the proposed standard(s) under consideration by this group and that are not already the subject of an Accepted Letter of Assurance, please respond at this time by providing relevant information to the WG Chair

b. **Copyright Policy:**

* + 1. By participating in this activity, you agree to comply with the IEEE Code of Ethics, all applicable laws, and all IEEE policies and procedures including, but not limited to, the IEEE SA Copyright Policy.

c.**Participation and policy related (including Patent and Copyright) slides: See slides 10-19 in** <https://mentor.ieee.org/802.11/dcn/22/11-22-2139-00-0000-2nd-vice-chair-report-january-2023.pptx>

d.**Agenda Approval**

2.       **Editor report** – Emily QI/Edward AU

3.       **Comment resolution and motions**

1. **Friday January 27, 2023 – 10am – noon Eastern**
   1. Comment resolution
      1. CID 3776 (MAC) – Hamilton (Ruckus/Commscope)
      2. CID 3819 (ED1) – doc 11-22/1993 – Kim (Qualcomm)
      3. CIDs 3568, 3567, 3658 (GEN) – Rosdahl (Qualcomm)
      4. CID 3263 (GEN) – Rison (Samsung)
      5. CID 3508 (MAC) – Hamilton (Ruckus/Commscope)
2. **Friday February 3, 2022 – 10am – noon Eastern**
   1. Comment resolution
      1. CID 3181 (MAC), 3185 (GEN), 3263 (GEN) – Rison (Samsung)
      2. GEN Discuss/Review CIDs – Rosdahl (Qualcomm)
3. **Monday February 6, 2022 – 10am – noon Eastern** 
   1. Comment resolution
      1. CID 3693 (ED2) – Rison (Samsung)
      2. CID 3057 (PHY) – Smith (SRT)
      3. MAC Discuss/Review CIDs – Hamilton (Ruckus/Commscope)
4. **Friday February 10, 2023 – 10am – noon Eastern** 
   1. Comment resolution
      1. CID 3009 (ED1) – Withdrawn
      2. CID 3488 (PHY) – Rison (Samsung)
      3. SEC CIDs – 11-22/2163 – Montemurro (Huawei)
5. **Monday February 13, 2023 – 10am – noon Eastern** 
   1. Comment resolution
      1. Announcement on S1G 1024 QAM – Halasz (Morse Micro)
      2. CID 3384 (MAC) – Halasz (Morse Micro)
      3. CID 3506, and 3507 – doc 11-22/2001 – Au (Huawei)
      4. GEN Discuss/Review CIDs – Rosdahl (Qualcomm)
6. **Friday February 17, 2023 – 10am – noon Eastern** 
   1. Motions
      1. Slides 7 – 9 in document 11-23/24r2
   2. Comment resolution
      1. CID 3175 (GEN), 3289 (MAC) – Rison (Samsung)
      2. CID 3000 (MAC) – doc 11-22/2208 - Patil (Qualcomm)
      3. Misc MAC CIDs – doc 11-23/162 – Huang (Intel)
      4. MAC Discuss/Review CIDs – Hamilton (Ruckus/Commscope)
7. **Friday February 24, 2023 – 10am – noon Eastern** 
   1. Comment resolution
      1. CID 3057 (PHY) – Rison (Samsung)
      2. CID 3262 (PHY) – Rison (Samsung)
      3. CID 3316 (GEN) – Smith (SRT)
      4. CID 3697, 3694, 3541, 3538, 3504, 3408, 3526, 3271 (PHY) – Rison (Samsung)
8. **Monday February 27, 2023 – 10am – noon Eastern** 
   1. Comment resolution
      1. 1024 QAM for S1G – doc 11-23/39 – Halasz (Morse Micro) [Up to 1 hr agenda time]
      2. CID 3038 (MAC) – doc 11-23/138 – Hart (Cisco)
      3. MAC Discuss/Review CIDs – Hamilton (Ruckus/Commscope)
9. **Friday March 3, 2023 – 10am – noon Eastern** 
   1. Comment resolution
      1. 11-22/1988 – Protected Password Identifiers – Harkins
      2. CID 3753 – doc 11-23/156 (SEC)– Huang (Intel)
      3. CID 3742 – doc 11-23/154 (SEC) – Huang (Intel)
      4. CID 3743, 3744, 3745, 3746 (SEC) – doc 11-23/153 – Huang (Intel)
      5. SEC CIDs – 11-22/2163 – Montemurro (Huawei)

5.       **AOB**

6. **Adjourn**

NOTES (Additional Queue):

* CID 3506, 3576, 3630, 3640 and 3724 – Au (Huawei)
* CID 3233 (ED1) – Qi (Intel).
* CID 3014 (MAC) – doc 11-22/2206 – Patil (Qualcomm)
* CID 3071, 3072 (PHY) – Shellhammer –
* CID 3712, 3632, 3566 (GEN) – March Plenary
* Discussion on NIST SHA-1 liaison/announcement

Teleconferences are subject to applicable policies and procedures, see below.

see <https://mentor.ieee.org/802.11/dcn/22/11-22-0856-00-0000-2nd-vice-chair-report-july-2022.pptx>

**References:**